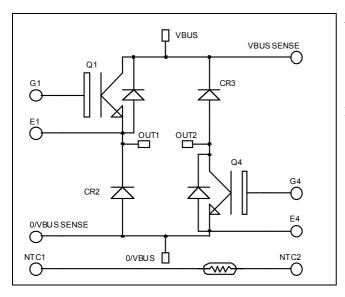


Asymmetrical - Bridge Trench + Field Stop IGBT3 Power Module

$$V_{CES} = 600V$$

 $I_{C} = 150A$ @ $Tc = 80$ °C



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Application

- Welding converters
- Switched Mode Power Supplies
- Uninterruptible Power Supplies
- Motor control

Features

- Trench + Field Stop IGBT3 Technology
 - Low voltage drop
 - Low tail current
 - Switching frequency up to 20 kHz
 - Soft recovery parallel diodes
 - Low diode VF
 - Low leakage current
 - RBSOA and SCSOA rated
- Kelvin emitter for easy drive
- Very low stray inductance
 - Symmetrical design
 - Lead frames for power connections
- Internal thermistor for temperature monitoring
- High level of integration



- Stable temperature behavior
- Very rugged
- Solderable terminals for easy PCB mounting
- Direct mounting to heatsink (isolated package)
- Low junction to case thermal resistance
- Easy paralleling due to positive TC of VCEsat
- Low profile
- RoHS Compliant

Absolute maximum ratings

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VBUS

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Symbol	Parameter		Max ratings	Unit
V_{CES}	Collector - Emitter Breakdown Voltage		600	V
ī	Continuous Collector Current	$T_C = 25^{\circ}C$	225	
I_{C}	Continuous Conector Current	$T_C = 80$ °C	150	A
I_{CM}	Pulsed Collector Current	$T_C = 25^{\circ}C$	350	
V_{GE}	Gate – Emitter Voltage		±20	V
P_{D}	Maximum Power Dissipation	$T_C = 25$ °C	480	W
RBSOA	Reverse Bias Safe Operating Area	$T_j = 150^{\circ}C$	300A @ 550V	

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NTC2

CAUTION: These Devices are sensitive to Electrostatic Discharge. Proper Handling Procedures Should Be Followed. See application note APT0502 on www.microsemi.com



All ratings @ $T_j = 25$ °C unless otherwise specified

Electrical Characteristics

Symbol	Characteristic	Test Conditions		Min	Typ	Max	Unit
I_{CES}	Zero Gate Voltage Collector Current	$V_{GE} = 0V, V_{CE} = 600V$				250	μΑ
V	Collector Emitter Saturation Voltage	$V_{GE} = 15V$	$T_j = 25$ °C		1.5	1.9	V
V _{CE(sat)}	Confector Emitter Saturation Voltage	$I_{\rm C} = 150A$	$T_j = 150$ °C		1.7		V
$V_{GE(th)}$	Gate Threshold Voltage	$V_{GE} = V_{CE}$, $I_C = 1.5 \text{ mA}$		5.0	5.8	6.5	V
I_{GES}	Gate – Emitter Leakage Current	$V_{GE} = 20V, V_{CE} = 0V$				400	nA

Dynamic Characteristics

Symbol	Characteristic	Test Conditions	Min	Тур	Max	Unit
C_{ies}	Input Capacitance	$V_{GE} = 0V$		9200		
Coes	Output Capacitance	$V_{CE} = 25V$		580		pF
C_{res}	Reverse Transfer Capacitance	f = 1MHz		270		
$T_{d(on)}$	Turn-on Delay Time	Inductive Switching (25°C)		115		
T_{r}	Rise Time	$V_{GE} = \pm 15V$		45		
$T_{d(off)}$	Turn-off Delay Time	$V_{Bus} = 300V$ $I_{C} = 150A$		225		ns
$T_{\rm f}$	Fall Time	$R_G = 3.3\Omega$		55		
$T_{d(on)}$	Turn-on Delay Time	Inductive Switching (150°C)		130		
$T_{\rm r}$	Rise Time	$V_{GE} = \pm 15V$ $V_{Bus} = 300V$		50		ns
$T_{d(off)}$	Turn-off Delay Time	$I_{\rm C} = 150 A$		300		113
T_{f}	Fall Time	$R_G = 3.3\Omega$		70		
Eon	Turn on Energy	$V_{GE} = \pm 15V$ $T_j = 25^{\circ}C$		0.85		mJ
Lon	Turn on Energy	$V_{Bus} = 300V$ $T_j = 150^{\circ}C$		1.5		1113
F	Turn off Energy	$I_C = 150A$ $T_j = 25^{\circ}C$		4.1		mJ
E_{off}	Turn off Energy	$R_G = 3.3\Omega$ $T_j = 150$ °C		5.3		1113

Reverse diode ratings and characteristics

Symbol	Characteristic	Test Conditions		Min	Typ	Max	Unit
V_{RRM}	Maximum Peak Repetitive Reverse Voltage			600			V
I_{RM}	Maximum Reverse Leakage Current	$V_{R} = 600 V$	$T_j = 25^{\circ}C$			250	μA
- Kivi		K	$T_i = 150^{\circ}C$			500	
I_{F}	DC Forward Current		$Tc = 80^{\circ}C$		150		Α
$V_{\scriptscriptstyle F}$	Diode Forward Voltage	$I_F = 150A$	$T_i = 25^{\circ}C$		1.6	2	V
V F	Diode i of ward voltage	$V_{GE} = 0V$	$T_{i} = 150^{\circ}C$		1.5		v
t _{rr}	Reverse Recovery Time	$\begin{array}{c} I_F = 150A \\ V_R = 300V \\ di/dt = 3000A/\mu s \end{array}$	$T_j = 25$ °C		130		ns
ι _{rr}	Reverse Recovery Time		$T_{j} = 150^{\circ}C$		225		113
Q_{rr}	Reverse Recovery Charge		$T_j = 25^{\circ}C$		6.9		μС
Qrr	Reverse Recovery Charge		$T_{j} = 150^{\circ}C$		14.5		μ
E_{r}	Reverse Recovery Energy		$T_j = 25$ °C		1.6		mJ
L _T	Reverse Receivery Energy		$T_{\rm j} = 150^{\circ}{\rm C}$		3.5		1113



 $Temperature \ sensor \ NTC \ (see \ application \ note \ APT0406 \ on \ www.microsemi.com \ for \ more \ information).$

	Symbol	Characteristic	Min	Тур	Max	Unit
ſ	R_{25}	Resistance @ 25°C		50		kΩ
Ī	B 25/85	$T_{25} = 298.15 \text{ K}$		3952		K

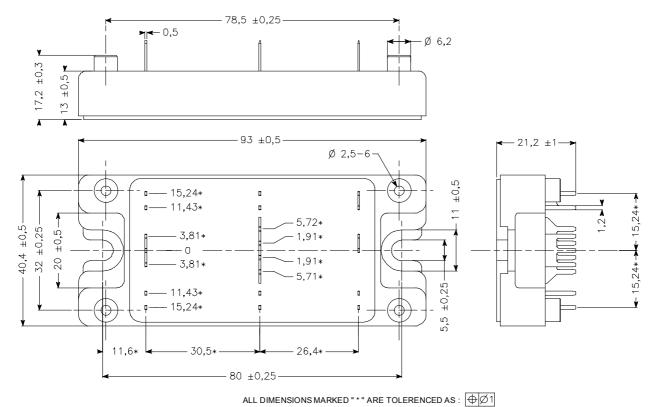
$$R_T = \frac{R_{25}}{\exp \left[\frac{1}{R_{25/85}} \left(\frac{1}{T_{25}} - \frac{1}{T} \right) \right]} \quad \text{T: Thermistor temperature}$$

$$R_T: \text{ Thermistor value at T}$$

Thermal and package characteristics

Symbol	Characteristic			Min	Тур	Max	Unit
R_{thJC}	Junction to Case Thermal Resistance		IGBT			0.31	°C/W
KthJC			Diode			0.52	C/W
V_{ISOL}	RMS Isolation Voltage, any terminal to case t =1 min, 50/60Hz			4000			V
T_{J}	Operating junction temperature range			-40		175	
T_{STG}	Storage Temperature Range		-40		125	°C	
$T_{\rm C}$	Operating Case Temperature			-40		100	
Torque	Mounting torque	To Heatsink	M5	2.5		4.7	N.m
Wt	Package Weight				160	g	

SP4 Package outline (dimensions in mm)

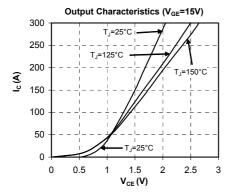


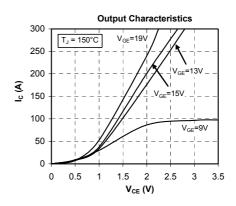
See application note APT0501 - Mounting Instructions for SP4 Power Modules on www.microsemi.com

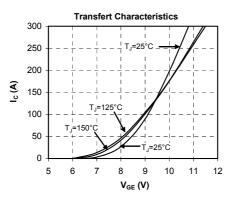
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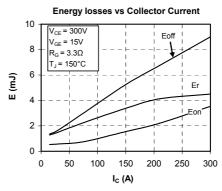


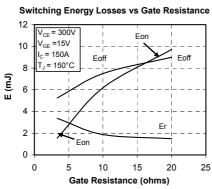
Typical Performance Curve

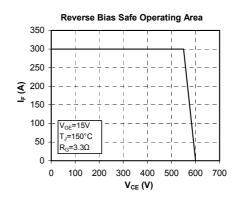


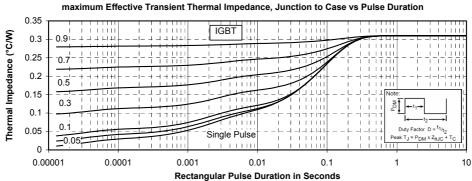




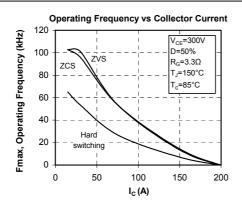


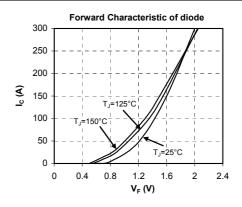


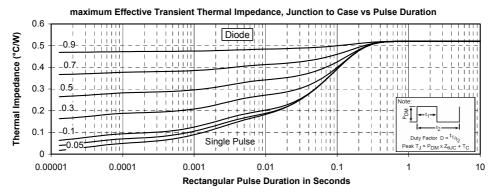












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FF600R12IE4V FF600R12IP4V FF800R17KP4_B2 FF900R12IE4V MIXA30W1200TED MIXA450PF1200TSF FP06R12W1T4_B3
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